SCOPE:

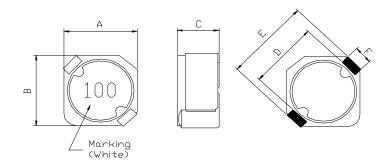
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-4D28C-SERIES

PRODUCT INDENTIFICATION

MSCDRI - 4D28C - 100 M

- (1)
- 2
- 3 4
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 5.10 Max. mm
B: 5.10 Max. mm
C: 3.00 Max. mm
D: 4.40 Typ. mm
E: 6.20 Max. mm
F: 1.40 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature $+60^{\circ}$ C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current	Monkina
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC(A)	Marking
MSCDRI-4D28C-1R1	1.1	N	100kHz/0.25V	22m	3.80	1R1
MSCDRI-4D28C-2R0□	2.0	M,N	100kHz/0.25V	29m	2.60	2R0
MSCDRI-4D28C-3R2□	3.2	N	100kHz/0.25V	42m	2.30	3R2
MSCDRI-4D28C-4R7□	4.7	M,N	100kHz/0.25V	63m	1.80	4R7
MSCDRI-4D28C-6R3□	6.3	N	100kHz/0.25V	94m	1.30	6R3
MSCDRI-4D28C-100□	10	M,N	100kHz/0.25V	0.106	1.26	100
MSCDRI-4D28C-150	15	M,N	100kHz/0.25V	0.137	1.05	150
MSCDRI-4D28C-220□	22	M,N	100kHz/0.25V	0.207	0.85	220
MSCDRI-4D28C-330□	33	M,N	100kHz/0.25V	0.331	0.70	330
MSCDRI-4D28C-470	47	M,N	100kHz/0.25V	0.510	0.54	470
MSCDRI-4D28C-680	68	M,N	100kHz/0.25V	0.625	0.49	680
MSCDRI-4D28C-101	100	M,N	100kHz/0.25V	0.948	0.40	101

[※] ☐ specify the inductance tolerance,M(±20%),N(±30%)

 \gg IDC : Based on inductance change (\triangle L/Lo : drop 35% max) @ ambient temp. 25° $\mathbb C$ and Based on temperature rise (\triangle T : 40° $\mathbb C$ TYP.)



(4) RELIABILITY TEST METHOD

MECHANICAL

SPECIFICATION	TEST DETAILS		
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
	in figure 1 and a load applied unitil the figure in the arrow		
There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
no mechanical	PCB dimension shall the page 7/9		
damage or elec-	F(Pressurization)		
trical damege.	Д		
	R5 45±2 45±2 10 20 R340		
	PRESSURE ROD figure-1		
∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
	and when a vibration having an amplitude of 1.52mm		
There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
damage.	(A total of 6 hours)		
New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
More than 90%	over the whole of the sample before hard, the sample shall		
	then be preheated for about 2 minutes in a temperature of		
	130∼150°C and after it has been immersed to a depth 0.5mm		
	below for 3±0.2 seconds fully in molten solder M705 with		
	a temperature of 245±5℃.		
	More than 90% of the electrode sections shall be couered		
	with new solder smoothly when the sample is taken out of		
	the solder bath.		
	There shall be no mechanical damage or electrical damege. △L/Lo≤±5% There shall be no mechanical damage.		



MECHANICAL

	SPECIFICATION					
There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 250±3°C 10 sec 150 250 Pre-heating Slow cooling (Stored at room temperature) 2 min or more The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.					
1	o damage or croblems.					

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20℃ ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM			SPECIFICATION				
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperat	a temperature of 85±2℃ and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sample	shall be left for 96+4 bo	urs in an atmosphere	with		
storage	∆DL03±3/6	The sample shall be left for 96±4 hours in an atmosphere with					
storag e	There shall be	a temperature of -25±3°C.					
		Upon completion of the test, the measurement shall be made					
	no mechanical		after the sample has been left in a normal temperature and				
	damage.	normal humidity for 1 hour.					
Change of	∆L/Lo≦±5%	-	The sample shall be subject to 5 continuos cycles, such as shown				
emperature		in the table 2 below and then it shall be subjected to standard					
	There shall be	,	atmospheric conditions for 1 hour, after which measurement				
	no other dama-	shall be ma	shall be made.				
	ge of problems						
			table 2				
			Temperature	Duration	1		
		1	-25±3 ℃	30 min.			
			(Themostat No.1)				
		2	Standard	No.1→No.2			
			atmospheric	110.1 > 110.2			
		3	85±2 ℃	30 min.			
			(Themostat No.2)				
		4	Standard	No.2→No.1			
			atmospheric	110.2 7110.1			
Moisuture storage	∆L/Lo≦±5%	The sample	e shall be left for 96±4 ho	urs in a temperature o	f		
		40±2℃ and a humidity(RH) of 90∼95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
	damage.	normal humidity more than 1 hour.					
Test conditions:	·	•					
The s	sample shall be reflo	w soldered o	nto the printed circuit boa	ard in every test.			

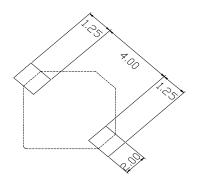


(5) LAND DIMENSION (Ref.)

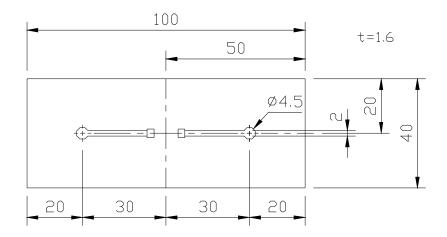
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm



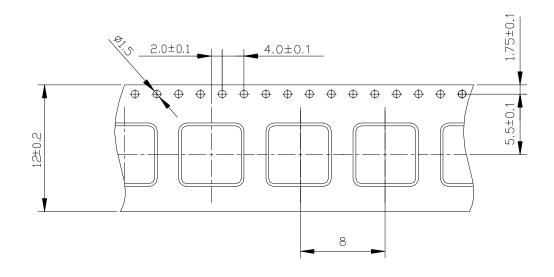
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD





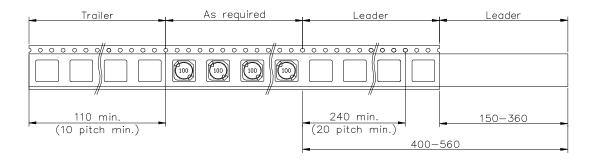
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

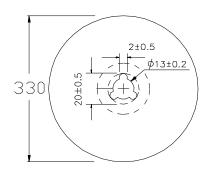


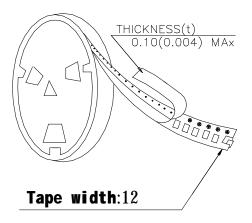
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

2000pcs/Reel

The products are packaged so that no damage will be sustained.